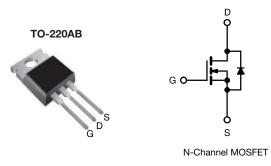
SiHP180N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.155			
Q _g max. (nC)	33			
Q _{gs} (nC)	7			
Q _{gd} (nC)	11			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP180N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	Ι _D	19	
	VGS AL TO V			12	Α
Pulsed drain current ^a			I _{DM}	44	
Linear derating factor				1.25	W/°C
Single pulse avalanche energy ^b			E _{AS}	111	mJ
Maximum power dissipation			PD	156	W
Operating junction and storage temperature ra	nge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	100	Mar	
Reverse diode dv/dt ^d			22	V/ns	
Soldering recommendations (peak temperature	e) c	For 10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.8 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62		°C (M)		
Maximum junction-to-case (drain)	R _{thJC}	- 0.8			°C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D = 2$	250 µA	3.0	-	5.0	V
	I _{GSS}	\	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage		N N	V _{GS} = ± 30	V	-	-	± 1	μA
Zara gata valtaga duain avuvant		V _{DS} =	600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	ار	₀ = 9.5 A	-	0.155	0.180	Ω
Forward transconductance a	9 _{fs}	V _{DS} =	= 20 V, I _D =	9.5 A	-	5.3	-	S
Dynamic					•	•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$		-	1085	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	56	-	pF	
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	- $V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$ -		-	41	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	251	-		
Total gate charge	Qg				-	22	33	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 9.5	A, V _{DS} = 480 V	-	7	-	nC
Gate-drain charge	Q _{gd}				-	11	-	
Turn-on delay time	t _{d(on)}				-	14	28	
Rise time	t _r	V _{DD} =	480 V, I _D =	= 9.5 A,	-	49	98	
Turn-off delay time	t _{d(off)}	$ V_{DD} = 480 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}, - 49 \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega - 22 $		44	44 ns			
Fall time	t _f				-	23	46	
Gate input resistance	Rg	f = 1	MHz, oper	n drain	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristi		•						
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19		
Pulsed diode forward current	I _{SM}			-	-	44	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 9.5 A	A, V _{GS} = 0 V	-	- 1	1.2	V
Reverse recovery time	t _{rr}				-	282	564	ns
Reverse recovery charge	Q _{rr}		°C, I _F = I _S		-	3.6	7.2	μC
Reverse recovery current	I _{RRM}	ai/at = 1	100 A/µs, \	$v_{\rm R} = 25 V$	-	24	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

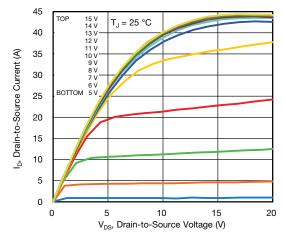


Fig. 1 - Typical Output Characteristics

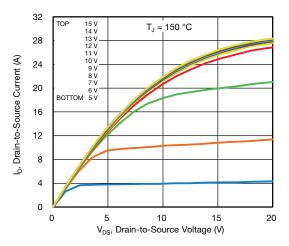


Fig. 2 - Typical Output Characteristics

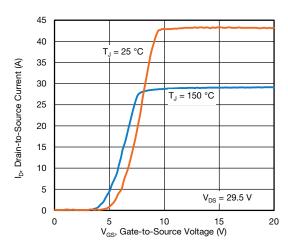


Fig. 3 - Typical Transfer Characteristics

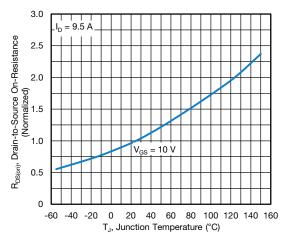


Fig. 4 - Normalized On-Resistance vs. Temperature

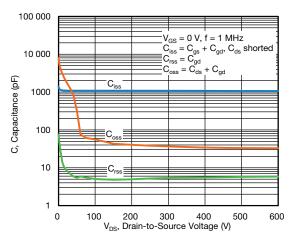


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

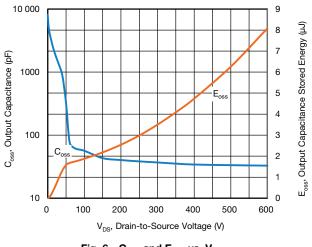


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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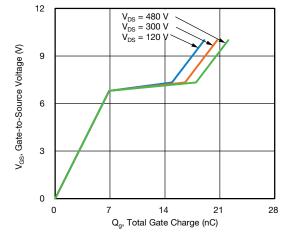


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

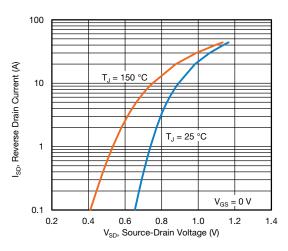


Fig. 8 - Typical Source-Drain Diode Forward Voltage

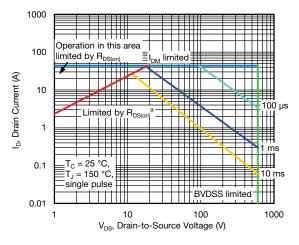


Fig. 9 - Maximum Safe Operating Area

Note

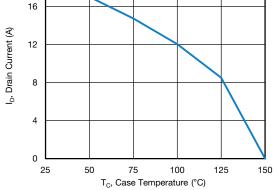
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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Fig. 10 - Maximum Drain Current vs. Case Temperature

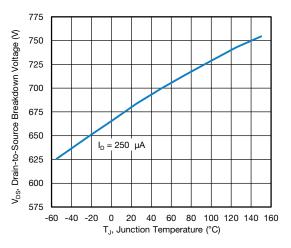
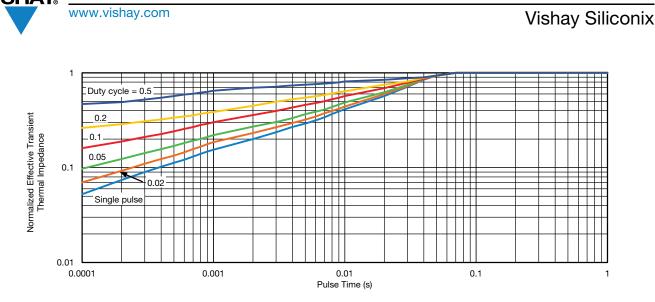


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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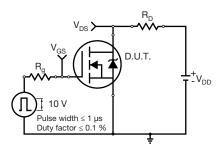


Fig. 13 - Switching Time Test Circuit

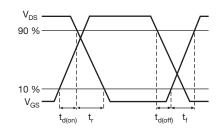


Fig. 14 - Switching Time Waveforms

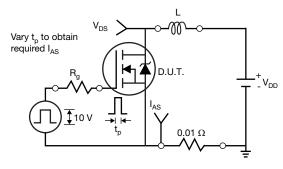


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

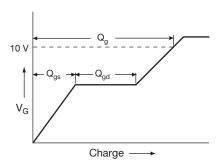


Fig. 17 - Basic Gate Charge Waveform

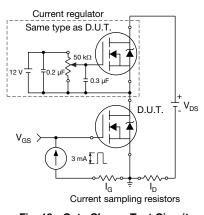


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

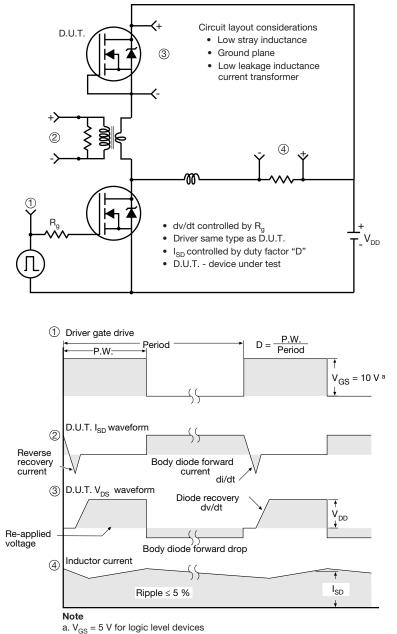


Fig. 19 - For N-Channel

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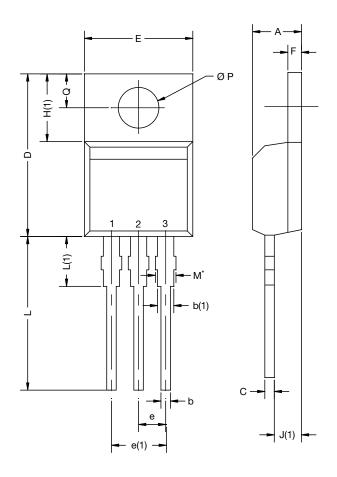
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TO-220-1



DIM.	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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